

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Appl. No. : 10/525,594 Confirmation No. 7944
Applicant : Ramil Vasquez *et al.*
Filed : 02/25/2005
TC/A.U. : 4116
Examiner : MEHTA, MEGHA S.

Docket No. : **GB02 0184 US**
Customer No. : 65913

Title: : Wedge-Bonding of Wires in Electronic Device Manufacture

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT & RESPONSE

Sir:

In response to the non-Final Office Action dated October 18, 2007, please consider the following:

Amendments to the Specification there are no amendments in this paper.

Amendments to the Claims begin on page 2 of this paper.

Remarks/Arguments begin on page 3 of this paper.